TOSHIBA GaAs Linear Integrated Circuit GaAs Monolithic

TG2211AFT

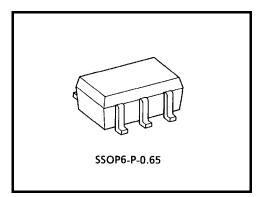
RF SPDT Switch

Antenna switch for Bluetooth class 2 and 3 Antenna switch for diversity Switch for receive filters for mobile handsets Switch for local signals

Features

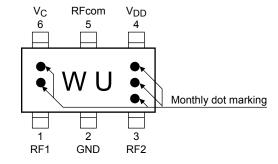
• Small external circuit: Built-in inverter

Low insertion loss : Loss = 0.45dB (typ.) @1.0 GHz
 High isolation : ISL = 25dB (typ.) @1.0 GHz
 Low voltage operation: VDD = VC (Hi) = 2.4 V (min.)
 Small package : SSOP6-P-0.65 (TU6) package (2.0 mm × 2.1 mm × 0.6 mm)

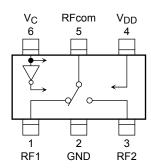


Weight: 0.0045 g (typ.)

Pin Configuration and Marking (top view)



Equivalent Circuit



Absolute Maximum Ratings (Ta = 25°C, Zg = ZI = 50 Ω)

Characteristic	Symbol	Conditions	Rating	Unit
Supply voltage	V_{DD}	P _i ≤ 15 dBmW	-0.5 (min.) / 6 (max.)	V
Control voltage	V _C	$P_i \le 15 \text{ dBmW}, V_C - V_{DD} \le 1.5 \text{ V}$	-0.5 (min.) / 6 (max.)	V
Input power	Pi	$V_{DD} = 2.4 \sim 2.7 \text{ V}, V_{C} = -0.2 \sim 3.3 \text{ V}$	25	dBmW
Total power dissipation	PD	(Note 1)	250	mW
Operating temperature range	T _{opr}	_	− 40 ~ 85	°C
Storage temperature range	T _{stg}	_	− 55 ~ 150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: When mounted on a 20 mm × 24 mm × 0.4 mm double-sided Teflon printed circuit board (the entire reverse side is a ground connection) at Ta = 25°C.

Caution

This device is sensitive to electrostatic discharge. When handling this product, ensure that the environment is protected against electrostatic discharge by using an earth strap, a conductive mat and an ionizer. See Note 5 for the power supply sequencing requirement.

Electrical Characteristics

 V_{DD} = 2.4 ~ 2.7 V, V_{C} (Hi) = 2.4 ~ 3.3 V, V_{C} (Lo) = 0 V, Ta = 25°C, Zg = ZI = 50 Ω , unless otherwise stated.

Characteristic		Symbol	Test Conditions	Min	Тур	Max	Unit
Insertion loss		Loss (1)	f = 1.0 GHz, P _i = 0 dBmW	_	0.45	0.75	
		Loss (2)	f = 2.0 GHz, P _i = 0 dBmW	_	0.5	0.8	
		Loss (3)	f = 2.5 GHz, P _i = 0 dBmW	_	0.6	0.85	
	hetween DEcom and DE1	ISL (1)	f = 1.0 GHz, P _i = 0 dBmW	20	25	_	
	between RFcom and RF1 between RFcom and RF2	ISL (2)	f = 2.0 GHz, P _i = 0 dBmW	20	25	_	dB
Isolation		ISL (3)	f = 2.5 GHz, P _i = 0 dBmW	20	24	_	
	between RF1 and RF2	ISL (4)	f = 1.0 GHz, P _i = 0 dBmW	20	25	_	
		ISL (5)	f = 2.0 GHz, P _i = 0 dBmW	17	20	_	
		ISL (6)	f = 2.5 GHz, P _i = 0 dBmW	14	17	_	
Input power at 1dB compression point (Note 3)		P _{i1dB} (1)	f = 1.0 GHz (Note 2)	17	23	_	
		P _{i1dB} (2)	f = 2.0 GHz (Note 2)	17	23	_	dBmW
		P _{i1dB} (3)	f = 2.5 GHz (Note 2)	16	22	_	
Supply current		I _{DD}	No RF signal (Note 2)	_	0.20	0.35	mA
Control current		IC	No RF signal (Note 2)	_	0.03	0.05	mA
Switching time		tsw	f = 100 MHz, P _i = 0 dBmW	_	80	200	ns

Note 2: When V_{DD} = 2.7 V, V_{C} (Hi / Lo) = 2.7 V / 0 V.

Recommended Operating Ranges (Ta = 25°C)

Characteristic	Characteristic Symbol		Тур	Max	Unit
Supply Voltage	V_{DD}	2.4	_	2.7	V
Control voltage	V _C (Hi)	2.4	_	3.3	V
Control voltage	V _C (Lo)	-0.2	0	0.2	V
Voltago difforence	V _{DD} - V _C (Lo)	2.4	_	2.9	V
Voltage difference	V _C (Hi) – V _{DD}	-0.2	0	0.6	V

Note 4: Always apply a voltage within the recommended range to V_{DD} pin when the device is operating, i.e. when any voltage other than 0 V is applied to V_C pin or RF signal is input to any RF port.

Switch Condition ($V_{DD} = 2.4 \sim 2.7 \text{ V}$)

V _C Voltage Level	Internal Connection	RFcom – RF1	RFcom – RF2
High	RFcom RF1	ON	OFF
Low	RFcom RF1	OFF	ON

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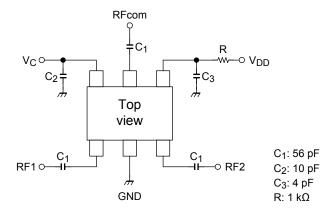
Note 3: P_{i1dB} is the input power level when the insertion loss increases by 1 dB from that of the linear range.

Pin Description

Pin No.	Symbol	Description		
1	RF1	RF port. Connected to RFcom when V_C = High. Connect the capacitor (C_1) to block internal DC voltage of the IC.		
2	GND	GND pin. Connect to the ground pattern of the circuit board.		
3	RF2	RF port. Connected to RFcom when V_C = Low. Connect the capacitor (C_1) to block internal DC voltage of the IC.		
4	V _{DD}	Power supply and RF-GND pin. Must be RF-grounded via the capacitor (C_3) , and should be done as close as possible for better RF performance. The value of the capacitor significantly affects the isolation. Connect the resistor (R) behind the capacitor to block RF leakage. Apply a voltage within the recommended range of V_{DD} to the far end of the resistor.		
5	RFcom	RF port. Connection can be switched to RF1 or RF2 by varying the level of the voltage applied to the V_C pin. Connect the capacitor (C_1) to block internal DC voltage of the IC.		
6	V _C	Switch connection control pin. The switch connections can be controlled by varying the level of the voltage to this pin. Connect the bypass capacitor (C_2) to the pin.		

Note 5: This device requires the power supply sequencing in which V_{DD} is powered up first and powered down last. Always apply a voltage within the recommended range to V_{DD} pin when the device is operating, i.e. when any voltage other than 0 V is applied to V_{C} pin or RF signal is input to any RF port.

RF Test Circuit



The values of external capacitors and resistor should be chosen to accommodate the operation frequency, bandwidth, switching speed and the pattern layout of the actual circuit board in the user's system. Be sure to take this into consideration when designing circuits.

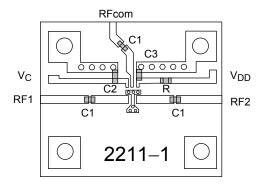
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List of External Components for Reference

	50~300 MHz	300~500 MHz	0.5~2.5 GHz	Chip Series	
C ₁	1000 pF	100 pF	56 pF	GRM1552C1H series MURATA	
C ₂	100 pF	10 pF	10 pF	GRM1552C1H series MURATA	
C ₃	100 pF	100 pF	4 pF	GRM1552C1H series MURATA	
R	1 kΩ	1 kΩ	1 kΩ	MCR01MZSJ series ROHM	

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Evaluation Board



Notice

The circuits and measurements contained in this document are given in the context of example applications of the product only.

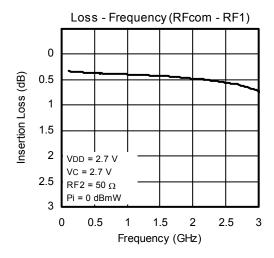
Moreover, these example application circuits are not intended for mass production since the high-frequency characteristics (i.e., the AC characteristics) of the device will be affected by the external components that the customer uses, by the design of the circuit and by various other conditions.

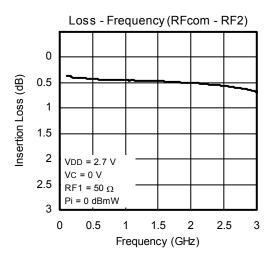
It is the responsibility of the customer to design external circuits that correctly implement the intended application and to check the characteristics of the design.

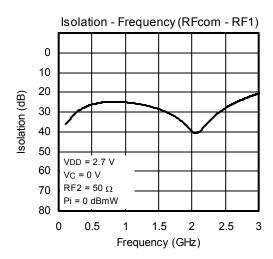
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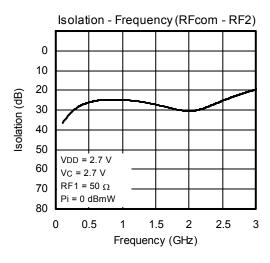
TOSHIBA assumes no responsibility for the integrity of customer circuit designs or applications.

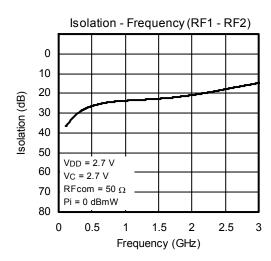
Typical Operating Characteristics

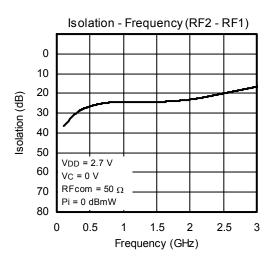






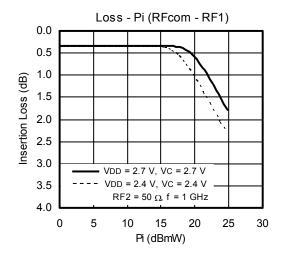


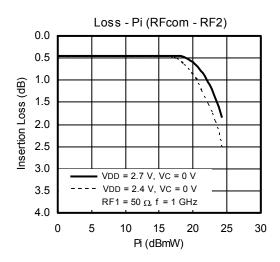


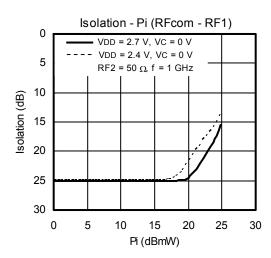


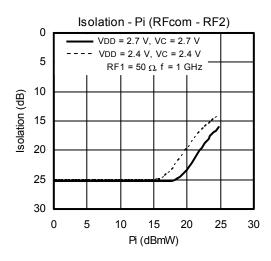
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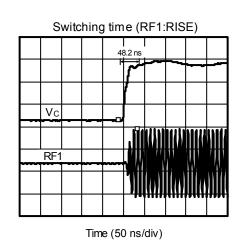
Typical Operating Characteristics (continued)

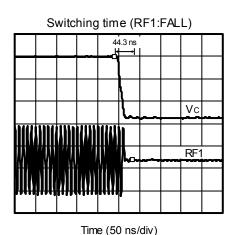








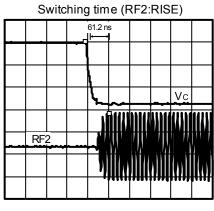




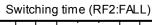
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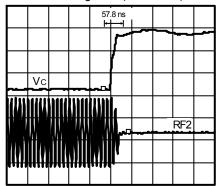
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Typical Operating Characteristics (continued)



Time (50 ns/div)

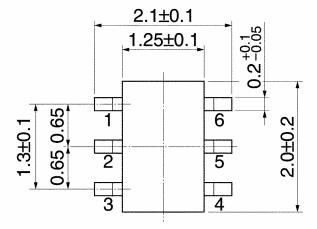


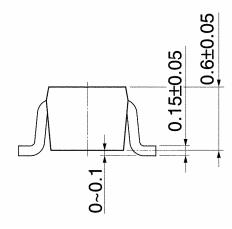


Time (50 ns/div)

Package Dimensions

SSOP6-P-0.65 Unit: mm





Weight: 0.0045 g (typ.)

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